

# **PRODUCT SPECIFICATION**

Part Number

# PCOG240160P-O Series

CUSTOMER	
CUSTOMER PART NUMBER	
DESCRIPTION	
APPROVED BY	
DATE	

MODEL	NO.	PAGE
PCOG240160P-O series	SPEC ONLY	2

No.	Contents	Page
1	Part number breakdown	4
2	Functions & features	5
3	Mechanical Specifications	5
4	Block Diagram	5
5	Dimensional Outline	6
6	LCD Driving voltage generator and bias reference circuit	7
7	Pin Description	8-9
8	Maximum Absolute Limit	10
9	Electrical Characteristics	10
10	Timing Characteristics	11-12
11	Control and Display Instruction	13-14
12	Electro-Optical Characteristics	15
13	Backlight Characteristics	15
14	Precautions	16-17
15	LCM Test Criteria	18-26

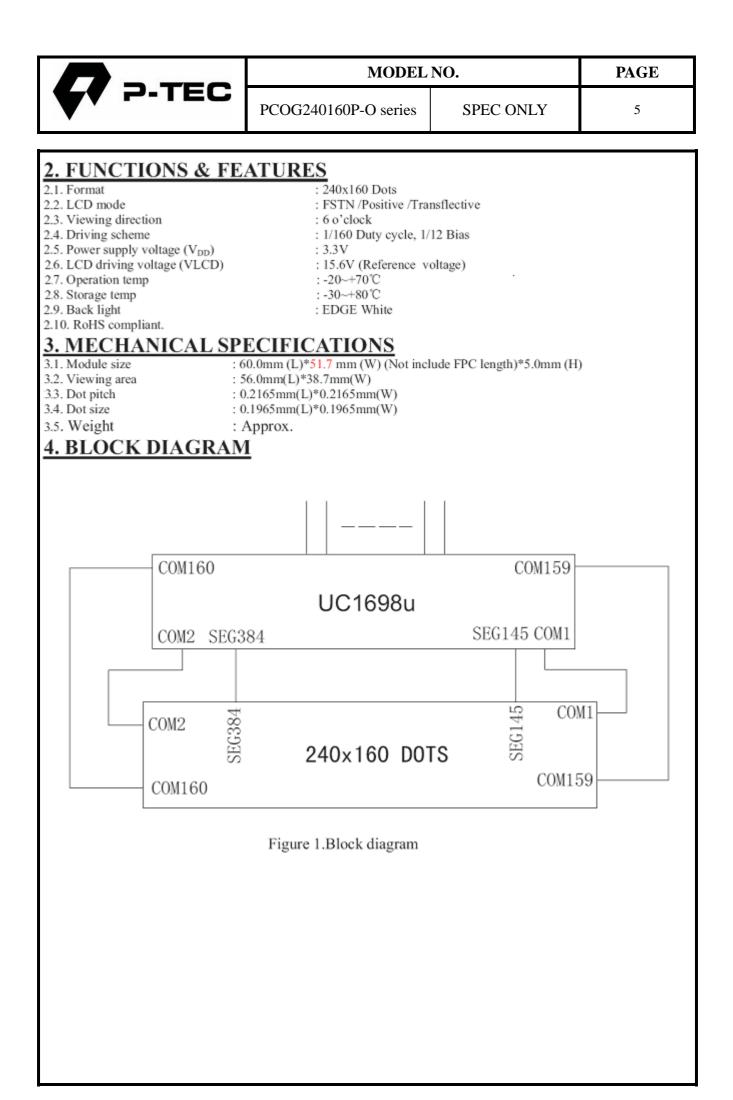


MODEL NO.

PAGE

Rev.	Comments	Page	Date
1	Preliminary Specification was first issued.	All	8/8'14

	MOD	EL N	NO.	PAGE				
P-TEC	PCOG240160P-O serie	es	SPEC ONLY	4				
1 <u>. Part number</u>	<u>breakdown</u>							
<b>P</b>	<b>-</b> 5 6 7 8 9							
Replace each Space (_ )	with the following letters	s and	d or numbers					
	G = Graphic T.	AB =	= Chip On Flex Tape Automated Bo Ihin-film Transistor	nding				
2. LCD Model	Example for Character: 2002A = 20 Characters x 2 Lines w/ Pins on Left side and 116mm x 37 x 12.7mm overall size Example for Graphic: 12864B = 128 Dots per row x 64 Dots per Column w/ Pins on lower side and 93mm x 70 x 8.8mm overall size							
<i>,</i> ,,	Y = STN/Yellow Green	B = STN/ Blue F = FSTN/ White N = FSTN/ Black						
4. Backlight/polorizer	NF = None/Transflective NM= None/Transmissive NR=None/Reflective EF= EL/Transflective EM= EL/Transmissive	LF= LED/Transflective LM= LED/Transmissive CF= CCFL/Transflective CM=CCFL=Transmissive						
5. Backlight Color	(If no backlight provided m B = Blue/Green Y = Yellow G = Green	S = ` O =	on to viewing angle   Yellow/Green Orange White	[6.])				
6. Viewing Angle	<b>D</b> = 6:00 <b>U</b> = 12:00		3:00 9:00					
7. Internal Number	Single Letter for internal pur	rpose	es	d Bonding 2 Lines w/ Pins on Left 2 Lines w/ Pins on Left x 37 x 12.7mm x 64 Dots per Column side and 93mm x 70 x e gle [6.]) andard 0°C to 50°C ng temperature				
8. Extended Temperature	This space is blank if operat An X will be visible if the LCI							
9. Customer Specials or List of Value-added items	Usually blank unless custom Can be several Letters long		quests some modifice	ations.				





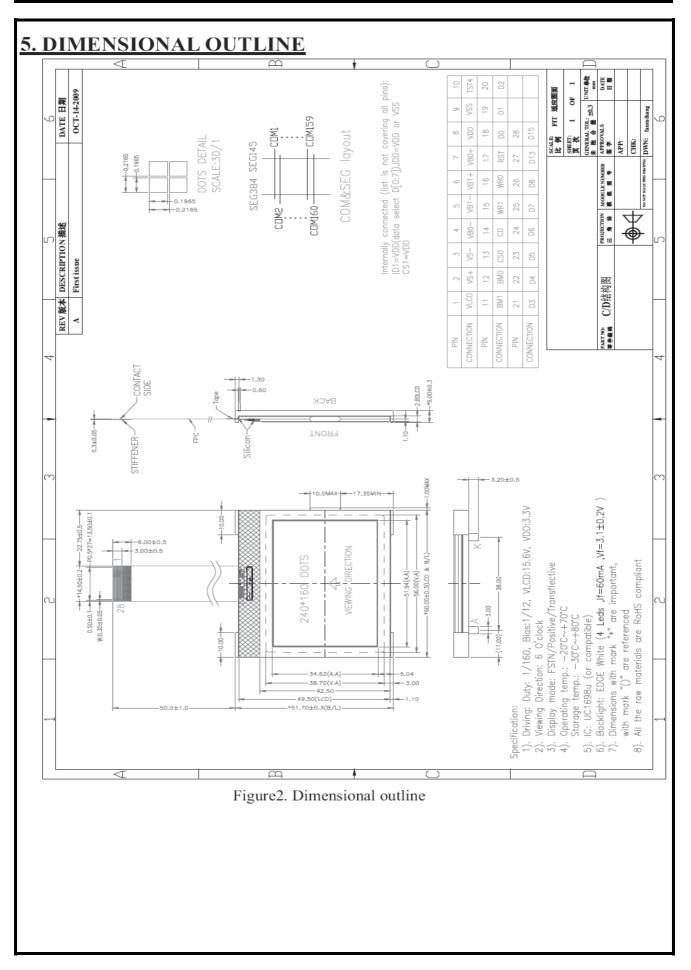
#### MODEL NO.

PAGE

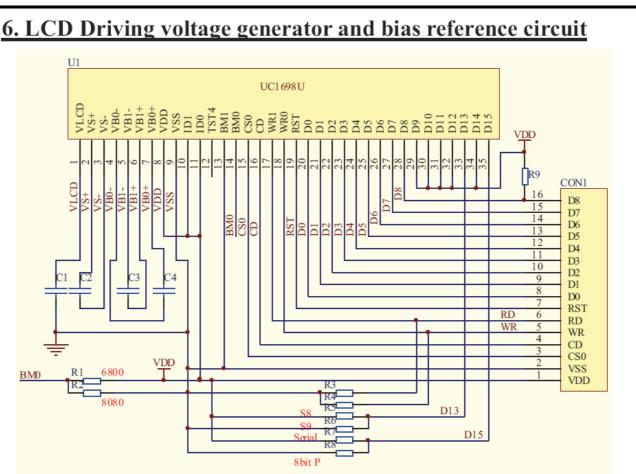
PCOG240160P-O series

SPEC ONLY

6







## NOTE:

Recommended component values:

C1,C3~C4: 1.0 to 4.7uF; C2: 0.1~1.0uF

R1~R9: select voltage level resistor, use 0 Ohm value to choose your application interface.



PCOG240160P-O series

SPEC ONLY

<u>7. PIN</u>	DESCRI	PTION										
No.	Symbol		Function									
1	VLCD	High voltage	High voltage LCD power supply. Connect a capacitor to VSS									
2	VS+	LCD SEG o	LCD SEG driving voltage, these voltages are generated internally,									
3	VS-	connect ca	connect capacitors between these terminals. Please find <u>section</u>									
4	VB0-	<u>5</u> for detail	<u>5</u> for details.									
5	VB1-		_									
6	VB1+											
7	VB0+											
8	VDD	Power Supp	oly (+3.0V).									
9	VSS	Power grou	nd.									
10	TST4	during norm TST4 is also	Test control. This pin has on-chip pull-up resistor. Leave it open during normal operation. TST4 is also used as one of the high voltage power supply for MTP programming operation.									
11	BM1		The interface bus i 3} by the following	mode is determined by BM[1:0] and								
		BM[1:0]	{DB15, DB13} Data	Mode 6800/16-bit								
		10	Data	8080/16-bit								
		01	0x	6800/8-bit								
12	BM0	00	0x	8080/8-bit								
12	Divio	00	10	4-wire SPI w/ 8-bit token (S8: conventional)								
		00	11	3/4-wire SPI w/ 8-bit token (S8uc: Ultra-Compact)								
		01	10	3-wire SPI w/ 9-bit taken (S9: conventional)								
13	CS0	Chip select	signal. chip is sele	ected when CS0="L".								
14	CD	Register sel CD = "H": di CD = "L": co	splay data.	69 mode CD pin is not used.								
15	WR1		ntrol the read/write at Interface for mor	e operation of the host interface. See								
16	WR0	In parallel n interface is	node, the meaning in the 6800 mode	of WR[1:0] depends on whether the or the 8080 mode. In serial interface t used, connect them to V <sub>SS</sub> .								
17	RST	Reset signa	I. Chip will be initi	alized when RST="L".								



PCOG240160P-O series

18~28	D0~D8, D13,D15	Bi-directional In serial mode DB0 DB1 DB2 DB3 DB4 DB5 DB6 DB7 DB8 DB7 DB8 DB9 DB10 DB11 DB12 DB12 DB13 DB14 DB15	· · · · · · · · · · · · · · · · · · ·			to SDA. BM=00 (S8/S8uc) SCK - - - - - - SDA - - - 0:S8/1:S8uc - 1	BM=01 (S9) SCK - - - - - SDA - - - - 0 - 1
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## 8. MAXIMUM ABSOLUTE LIMIT

Maximum Ratings (Voltage Reference to VSS)(for IC)

#### ABSOLUTE MAXIMUM RATINGS

In accordance with IEC134, Note 1 and 2

Symbol	Parameter	Min.	Max.	Unit
VDD	Logic Supply voltage	-0.3	+4.0	V
V <sub>DD2</sub>	LCD Generator Supply voltage	-0.3	+4.0	V
V <sub>DD3</sub>	Analog Circuit Supply voltage	-0.3	+4.0	V
$V_{DD2/3}$ - $V_{DD}$	Voltage difference between $V_{\text{DD}}$ and $V_{\text{DD2/3}}$		1.6	V
VLCD	LCD Driving voltage (-25°C ~ +75°C)	-0.3	+19.8	V
VIN	Digital input signal	-0.4	V <sub>DD</sub> + 0.5	V
T <sub>OPR</sub>	Operating temperature range	-30	+85	°C
T <sub>STR</sub>	Storage temperature	-55	+125	°C

#### NOTE:

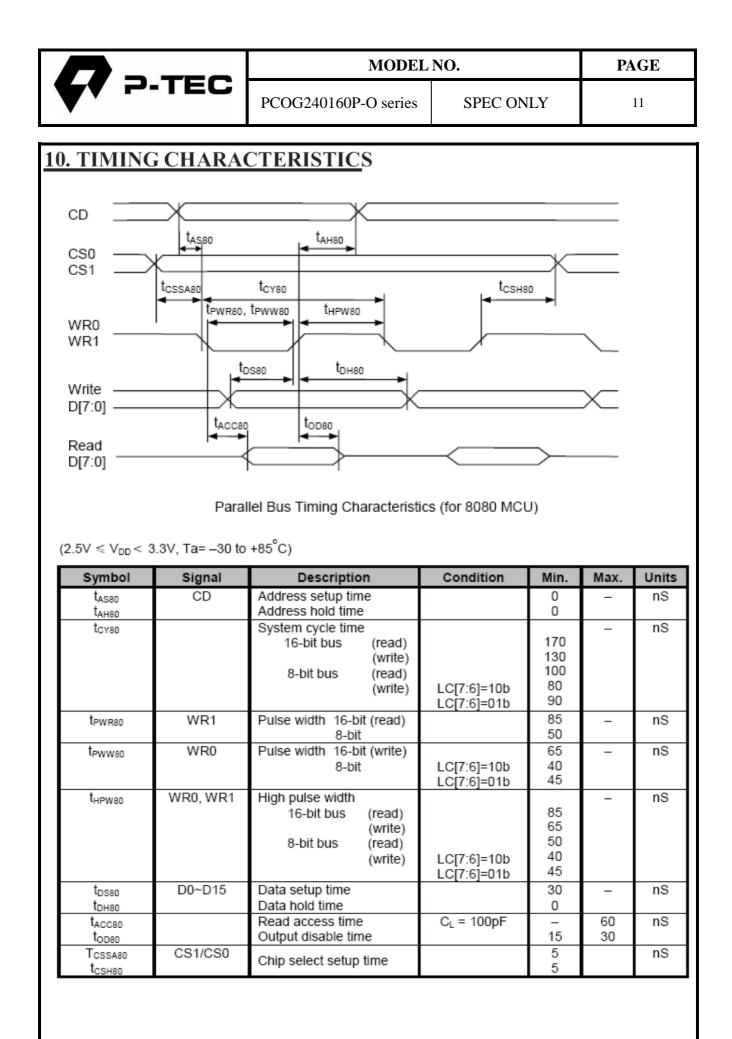
- 1.  $V_{DD}$  is based on  $V_{SS} = 0V$
- 2. Stress beyond ranges listed above may cause permanent damages to the device.

## **9. ELECTRICAL CHARACTERISTICS**

DC CHARACTERISTICS

#### DC CHARACTERISTICS

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
VDD	Supply for digital circuit		1.65		3.3	V
V <sub>DD2/3</sub>	Supply for bias & pump		2.7		3.3	V
V <sub>LCD</sub>	Charge pump output	V <sub>DD2/3</sub> = 2.8V, 25 <sup>0</sup> C		15.2	18	V
VD	LCD data voltage	V <sub>DD2/3</sub> = 2.8V, 25 <sup>0</sup> C	1.09		1.95	V
VIL	Input logic LOW				$0.2V_{DD}$	V
VIH	Input logic HIGH		$0.8V_{DD}$			V
Vol	Output logic LOW				0.2V <sub>DD</sub>	V
Voн	Output logic HIGH		$0.8V_{DD}$			V
١L	Input leakage current				1.5	μΑ
I <sub>SB</sub>	Standby current	$V_{DD} = V_{DD2/3} = 3.3V,$ Temp = 85°C			50	μΑ
CIN	Input capacitance			5	10	PF
COUT	Output capacitance			5	10	PF
Ron(seg)	SEG output impedance	V <sub>LCD</sub> = 16.5V		850	1100	Ω
Ron(COM)	COM output impedance	V <sub>LCD</sub> = 16.5V		950	1100	Ω
f <sub>LINE</sub>	Average line rate	LC[4:3] = 10b, 25 <sup>0</sup> C	-10%	37.0	+10%	Klps



	MODEL	PAGE	
P-TEC	PCOG240160P-O series	SPEC ONLY	12
RESET TIMING			
RST	t <sub>RW</sub>	t <sub>RD</sub>	
WR[1:0]			

Reset Characteristics

(1.65V ≤ V<sub>DD</sub> < 3.3V, Ta= –30 to +85<sup>°</sup>C)

Symbol	Signal	Description	Condition	Min.	Max.	Units
t <sub>RW</sub>	RST	Reset low pulse width		3	-	μS
t <sub>RD</sub>	RST, WR	Reset to WR pulse delay		10	-	mS

		C	P	COG	2401	60P.						ONLY	<b>PAGE</b>	
			r v	PCOG240160P-O series SPEC ONLY					15					
1	CONTROLAN		DIC	DI	۸V	ING	СТР		TT	ON				
	he following is a list of hos													
	C/D: 0: Control,		1	: Data	a									
	W/R: 0: Write Cycle, #: Useful Data bits			:Rea :Do										
_	Command	CID	W/R		D6	D5	D4	D3	D2	D1	D0	Actio		Defeult
1	Write Data Byte	1	0	#	#	#	#	#	#	#	#	Write 1		Default N/A
2	Read Data Byte	1	1	#	#	#	#	#	#	#	#	Read 1		N/A
	· · · · ·	-		GE	MX	MY	WA	DE	WS	MD	MS	Get {Statu	s. Ver.	
3	Get Status & PM	0	1	Ver				MO[6:				PMO, Produ		N/A
_	Set Column Address LSB	0	0	9rc 0	oduct (	Code (	(8h) 0	PID #	[1:0] #	MID #	[1:0] #	PID, M Set CA		0
4	Set Column Address LSB	0	0	0	0	0	1	<i>#</i>	#	#	#	Set CA		0
5	Set Temp. Compensation	Ő	Ő	0	Ō	1	Ö	ŏ	1	#	#	Set TC		0
6	Set Power Control	0	0	0	0	1	0	1	0	#	#	Set PC	1:0]	10b
7	Set Adv. Program Control	0	0	0	0	1	1	0	0	0	R	Set APC[F	R][7:0],	N/A
	(double-byte command)	0	0	# 0	#	#	#	#	#	#	#			
8	Set Scroll Line LSB Set Scroll Line MSB	0	0	0	1	0	1	#	#	#	#	Set SL Set SL		0
_	Set Row Address LSB	0	0	0	1	1	0	#	#	#	#	Set SE		0
9	Set Row Address MSB	0	0	0	1	1	1	#	#	#	#	Set RA		Ö
10	Set V <sub>BIAS</sub> Potentiometer (double-byte command)	0	0	1 #	0 #	0 #	0 #	0 #	0 #	0 #	1 #	Set PM	[7:0]	40H
11	Set Partial Display Control	0	0	1	0	0	0	0	1	0	#	Set LC	[8]	0
12	Set RAM Address Control	0	0	1	0	0	0	1	#	#	#	Set AC		001b
13	Set Fixed Lines	0	0	1 #	0 #	0 #	1 #	0 #	0 #	0 #	0 #	Set {FLT,	FLB}	0
14	Set Line Rate	0	0	1	0	1	0	0	0	#	#	Set LC	4:3]	10b
15	Set All-Pixel-ON	0	0	1	0	1	0	0	1	0	#	Set DC		0
16	Set Inverse Display	0	0	1	0	1	0	0	1 #	1 #	#	Set DO		0
17 18	Set Display Enable Set LCD Mapping Control	0	0	1	0	1	0	1	#	#	#	Set DC Set LC		110b 0
19		0	0	1	1	0	0	1	0	0	0	Set NIV	-	1DH
20	Set Color Pattern	0	0	- 1	- 1	- 0	#	#	#	#	#	Set LC		0 (BGR)
20	Set Color Mode	0	0	1	1	0	1	0	1	#	#	Set LC		10b
22	Set COM Scan Function	ŏ	Ő	1	1	ŏ	1	1	#	#	#	Set CSF		000b
23	System Reset	0	0	1	1	1	0	0	0	1	0	System [	Reset	N/A
24	NOP	0	0	1	1	1	0	0	0	1	1	No oper		N/A
25	Set Test Control (double-byte command)	0	0	1 #	1 #	1 #	0 #	0 #	1 #	T #	 #	For testin Do not		N/A
26	Set LCD Bias Ratio	0	0	# 1	# 1	# 1	0	1	0	#	#	Set BR		11b: 12
27	Set COM End	0	ŏ	1	1	1	1	0	0	0	1	Set CEN		159
-1		0	0	-	#	#	#	#	#	#	#	Secuel	-[0.0]	159
28	Set Partial Display Start	0	0	1	1 #	1 #	1 #	0 #	0 #	1 #	0 #	Set DST	[6:0]	0
29	Set Partial Display End	0	0	1	1 #	1 #	1 #	0 #	0 #	1 #	1 #	Set DEN	<b>I</b> [6:0]	159
30	Set Window Program	0	0	1	1 #	1	1 #	0 #	1 #	0	0 #		Set WPC0	0
_	Starting Column Address Set Window Program	0	0	- 1	# 1	#	#	#	#	#	#		Set	-
31	Starting Row Address	ŏ	ŏ	#	#	#	#	#	#	#	#	Shared	WPP0	0
32	Set Window Program Ending Column Address	0	0	1	1 #	1 #	1 #	0 #	1 #	1 #	0 #	with MTP commands	Set WPC1	127
33	Set Window Program	0	0	1	1 #	1	1	0 #	1	1 #	1 #		Set WPP1	159
34	Ending Row Address Window Program Mode	0	0	#	#	#	#	#	#	#	#	Set AC		0: Inside
_	Set MTP Operation control	0	0	1	0	1	1	1	0	0	0 #	Set MTP		10H
		0	0	-	-	-	#	#	#	#	#		1 1	

	MODEL	NO.	PAGE
P-TEC	PCOG240160P-O series	SPEC ONLY	14

Command		C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0	Actio	n	Default
36	Set MTP Write Mask	0 0 0	0 0 0	1 - -	0 # -	1 # -	1 # -	1 # -	0 # -	0 # #	1 # #	Set MTPN MTPM1[		0
37	Set V <sub>MTP1</sub> Potentiometer	0 0	0 0	1 #	1 #	1 #	1 #	0 #	1 #	0 #	0 #		Set MTP1	N/A
38	Set $V_{MTP2}$ Potentiometer	0 0	0 0	1 #	1 #	1 #	1 #	0 #	1 #	0 #	1 #	Shared with Window	Set MTP2	N/A
39	Set MTP Write Timer	0 0	0 0	1 #	1 #	1 #	1 #	0 #	1 #	1 #	0 #	Program commands	Set MTP3	N/A
40	Set MTP Read Timer	0 0	0 0	1 #	1 #	1 #	1 #	0 #	1 #	1 #	1 #		Set MTP4	N/A

NOTE:

· All other bit patterns other than commands listed above may result in undefined behavior.

- The interpretation of commands (36)~(40) depends on the setting of register MTPC[3].
  - Commands (37)~(40) are shared with commands (30)~(33). These two sets of commands share exactly the same code and control registers. When MTPC[3]=0, they are interpreted as Window Program commands and registers. When MTPC[3]=1, they function as MTP Control commands and registers.
- After MTP ERASE or PROGRAM operation, before resuming normal operation, please always

   a) Remove TST4 power source,
  - b) Do a full V<sub>DD</sub> ON-OFF-ON cycle.
- Under 16-bit bus mode and CD=0, D[15:8] is ignored and only D[7:0] is used. As a result, the bus cycles
  for commands under 16-bit bus and 8-bit bus are the same, and double-byte commands still need two
  bus cycles under 16-bit bus mode.

Example:

8-bit bus mode:

Set PL[1:0] = 2'b11 :  $D[7:0] = 0010 \ 1011$ Set PM[7:0] = 8'h8b : 1<sup>st</sup>  $D[7:0] = 1000 \ 0001$  $2^{nd} D[7:0] = 1000 \ 1011$ 

16-bit bus mode:

Set PL[1:0] = 2'b11:	D[15:0] = 0000 0	000 0010 1011
Set PM[7:0] = 8'h8b: 1 <sup>st</sup>	D[15:0] = 0000 0	000 1000 0001
2 <sup>n</sup>	i D[15:0] = 0000 0	000 1000 1011



PAGE

PCOG240160P-O series

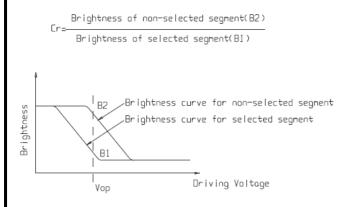
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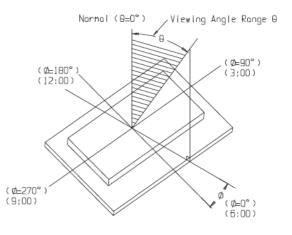
# **12. ELECTRO-OPTICAL CHARACTERISTICS**

 $(V_{DD} = 3.3V, Ta = 25^{\circ}C)$ 

Item	Symbol	Condition	Min	Тур	Max	Unit
Operating Voltage		Ta =-20°C	15.8	16.1	16.4	
Operating Voltage for LCD	Vop	$Ta = 25^{\circ}C$	15.3	15.6	15.9	V
		$Ta = 70^{\circ}C$	14.8	15.1	15.4	
Desugarda	Tr	$Ta = 25^{\circ}C$		250	500	ms
Response time	Tf	1a - 25 C		300	600	ms
Contrast	Cr	$Ta = 25^{\circ}C$	2	4		
Viewing angle range	θ	Cr>2	-35		+35	deg
Viewing angle range	Φ	CI22	-35		+40	deg

The following charts is for your reference of the data in the above form.





# **13. BACK LIGHT CHARACTERISTICS**

LCD Module with edge LED Backlight. Electrical ratings.  $Ta = 25^{\circ}C$ 

Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	IF	IF=60 mA	2.9	3.1	3.3	V
Reverse Current	IR	VR=0.8V		20		mA
Luminous Intensity (Without LCD)	LV	IF=60 mA	350	400		Cd/m <sup>2</sup>
Wave length	λρ	IF=60 mA	X=0.28 Y=0.28		X=0.32 Y=0.32	nm
Color			white			

Note:

when the temperature exceed 25 °C, the approved current decrease rate for Backlight change as the temperature increase is: -0.36\*4mA/°C (below 25 °C, the current refer to constant, which would not change with temperature ).



# **14. PRECAUTION FOR USING LCD/LCM**

After reliability test, recovery time should be 24 hours minimum. Moreover, functions,

PCOG240160P-O series

performance and appearance shall be free from remarkable deterioration within 50,000

hours(average) under ordinary operating and storage conditions room temperature ( $20\pm8^{\circ}$ C), normal humidity (below 65% RH), and in the area not exposed to direct sun light. Using LCM beyond these conditions will shorten the life time.

Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any

alteration or modification. The followings should be noted.

## **General Precautions:**

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not made any modification on the PCB without consulting P-tec.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or

twisting. Elastomer contacts are very delicate and missing pixels could result from slight

dislocation of any of the elements.

6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and

lose contact, resulting in missing pixels and also cause rainbow on the display.

7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

## **Static Electricity Precautions:**

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.

MODEL	NO.	PAGE
PCOG240160P-O series	SPEC ONLY	17

- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

#### Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: 280°C+10°C
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

#### **Operation Precautions:**

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

#### Limited Warranty

P-tec LCDs and modules are not consumer products, but may be incorporated by P-tec's customers into consumer products or components thereof, P-tec does not warrant that its LCDs and components are fit for any such particular purpose.

- The liability of P-tec is limited to repair or replacement on the terms set forth below. P-tec will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between P-tec and the customer, P-tec will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with P-tec general LCD inspection standard . (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.



# 15. LCM TEST CRITERIA

### 1. Objective

The criteria is made for customer and company to check on delivery LCM end product, guarantee the production quality to meet with customer's demand.

### 2. Range

2.1 Suit for our company's LCD end production.

### 3. Testing equipment

Function tester, sliding calipers, microscope, visual magnifying glass, ESD arm protector, finger cover, label, high-low temperature experiment case, refrigerator, fixed-voltage power supply (DC), table lamp and so on.

#### 4. Sampling plan and quote superscript

4.1.1 According to GB/T 2828.1---2003/ISO2859-1:1999, normal check of one sampling plan, general level of inspection II.

Testing item	Sample quantity	AQL judgment
cosmetic	II one time sample	MA=0.4 MI=1.5
scale	N=3	C=0
function	II one time sample	MA=0.4 MI=1.5

4.1.2 GB/T 2828.1---2003/ISO2859-1:1999 check and count the sampling procedure and table one by one.

4.1.3 GB/T 1619.96 Test method of twisting out LCD device.

4.1.4 GB/T 12848.91 General standard of super-out LCD device.

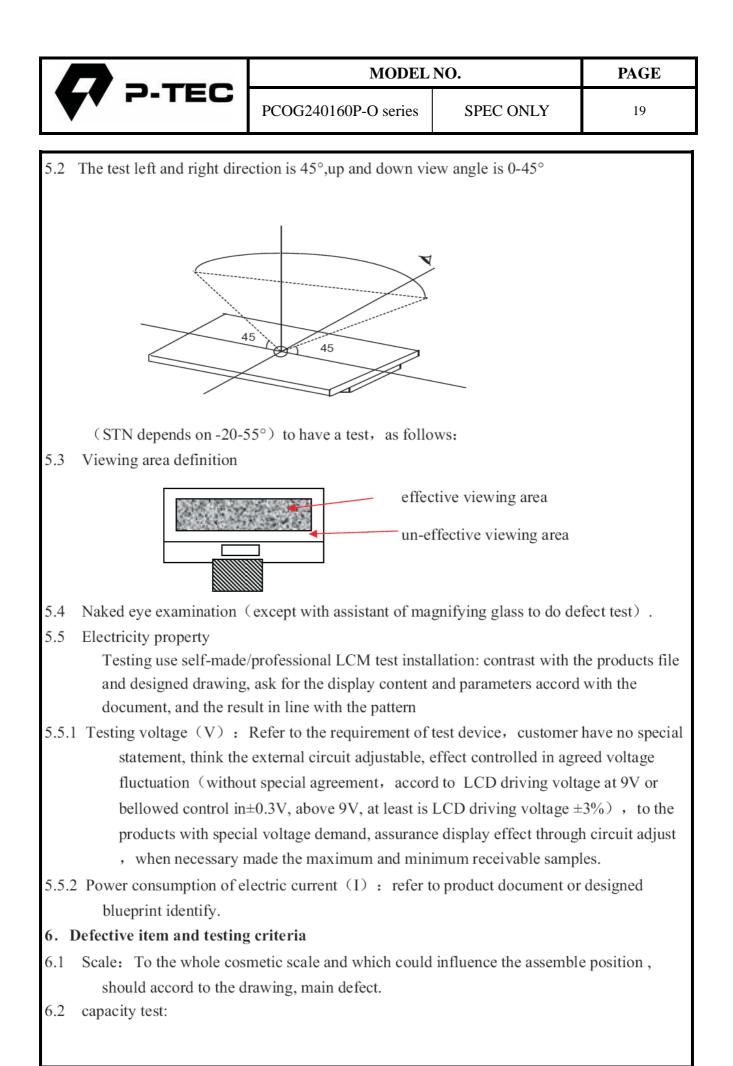
4.1.5 GB2421-89 Basic experience environment of electrical and electronic products

4.1.6 IPC-A-610C Check condition of electrical assemblies.

## 5. Test condition and basis

5.1 visual: General under the condition of  $25\pm5$  °C,  $45\pm20$ %RH, with enough light (

>300cd/cm2), the distance between operator and LCD is 30cm, use the method of reflective to test is normal, the backlight products, must test under the condition of luminance smaller than 100cd/cm2, and lit up the backlight.



7	P-TEC

PAGE

PCOG240160P-O series

order	item	description	MAJ	MIN	Accept standard
6.2.1	Segment missing	SEG/COM showed line or spot missing caused by line break/bad connection, i8nner short	$\checkmark$		reject
6.2.3	No display/no action	Normal connection, no display	V		reject
6.2.4	mistake/abnormal	Accord to common scanner procedure, picture and order inconsistent with requirement			reject
6.2.5	Viewing angle mistake	The clearest direction inconsistent with requirement	$\checkmark$		reject
6.2.6	Display dark/light	Normal display the whole ratio too light or dark	$\checkmark$		Over voltage standard,reject
6.2.7	Slow reflect	Reflection of lit or off on part dose not uniform with others.	$\checkmark$		reject
6.2.8	Show more symbol, more lines and rows	due to lack of matching unrightenousness or etched caused alignment or logo when lit display of symbols, row or line.		$\checkmark$	refer to spot/line standard
6.2.9	light/dim segment	On the condition of normal voltage, the display contrast is not uniformed		$\checkmark$	Reject or refer to samples
6.2.10	PI black/white spot	Poor connect in LCD lead to black/white spot in word change procedure		$\checkmark$	Suspended screen, refer to spot/line, others OK
6.2.11	pinhole/white spot	ITO missing lead to picture incomplete when lit up d = (X+Y)/2		$\checkmark$	refer to spot/line standard
6.2.12	word deformed	Mistaken match caused the display width dose not conform to standard, then lead to convex or air leakage:  Ia- Ib ≤1/4W(W is the normal width)		V	accept  Ia-Ib >1/4W, reject
6.2.13	High current	LCM current exceed requirement			reject
	D visual defect spot defect(controll	ed in viewing area, in un-viewing area, Ok	()		

L/	<b>P-TEC</b>		MO	DEL NO				PAGE
•		PCOG2401	PCOG240160P-O series SPEC ON		SPEC ONI	X		21
De	efective item	average dian	neter (d	1.000	nt number	м	AJ	MIN
		)		Acce	pt number	IVI	AJ	IVITIN
Spot defect (black spot, impurity, pinhole,, contain LC defect)		d≤0.2			3			1
		0.2 <d≤0< td=""><td></td><td></td><td>2</td><td></td><td></td><td></td></d≤0<>			2			
pinnoie,, c	contain LC defect)	0.25 <d≤< td=""><td>0.30</td><td></td><td>1</td><td></td><td></td><td></td></d≤<>	0.30		1			
6.3.2 Lin	e defect(controlled i	n viewing area,	in un-viev	ving area	, OK)			
	efective item	length(L)	) W	vidth(W)	Accept nur	nber	MAJ	MIN
line defect impurity)	t (segment,	≤5.0		≤0.02	3			1
impunty)		≤3.0		≤0.03	3			$\checkmark$
note: 1.v	when width is bigger	$\leq 3.0$	1- 4- 1 1	<u>≤0.05</u>	1 1 1 1			
De	arizer air bubble (con fective item	average diame	•		pt number		AJ	MIN
polarizer air bubble, convex point		d≤0.3			3			
		0.3 <d≤0.5< td=""><td></td><td>2</td><td></td><td></td><td>1</td></d≤0.5<>			2			1
	↓ W	0.5 <d≤0.8< td=""><td></td><td colspan="2">1</td><td></td><td>N</td></d≤0.8<>			1			N
Ţ	d=(w+1)/2				•			
іЦ								
	maged(LCD edge rev		1					
6.3.4 Dar order	item		1	e, contain ermit star	ndard	duct I M/		ctly) MIN
			P		ndard (mm)			
	item		P X		$\frac{(\text{mm})}{\leq 1/8L}$			MIN
	item		P X Y		$\frac{(mm)}{\leq 1/8L}$ $\leq 1/3W$			
order	item		P X Y Z	ermit star	$\frac{(\text{mm})}{\leq 1/8\text{L}}$ $\leq 1/3\text{W}$ $\leq 1/2\text{t}$			MIN
order	item		P X Y Z Accep numbe	ermit star	$\frac{(\text{mm})}{\leq 1/8\text{L}}$ $\leq 1/3\text{W}$ $\leq 1/2\text{t}$ $2$	M	AJ	MIN
order	item		P X Y Z Accep numbe When Y	ermit star	$\frac{(\text{mm})}{\leq 1/8\text{L}}$ $\leq 1/3\text{W}$ $\leq 1/2\text{t}$	M/	AJ	MIN √
order	item Conductor chips	Z	P X Y Z Accep numbe When Y	ermit star	ndard (mm) $\leq 1/8L$ $\leq 1/3W$ $\leq 1/2t$ 2 neglect the let depend on X (mm)	M/ ngth c ≤1/10	AJ	MIN √
order 6.3.4.1	item	Z	P X Y Z Accep numbe When Y	ermit star	ndard (mm) $\leq 1/8L$ $\leq 1/3W$ $\leq 1/2t$ 2 neglect the leadepend on X (mm) enter into	M/ ngth c ≤1/10	AJ of X, un L, Y≤	MIN √
order 6.3.4.1	item Conductor chips	Z	P X Y Z Accep numbe When Y conducto	ermit star	ndard (mm) $\leq 1/8L$ $\leq 1/3W$ $\leq 1/2t$ 2 neglect the let depend on X (mm)	M/ ngth c ≤1/10	AJ of X, un L, Y≤	MIN √
order 6.3.4.1	item Conductor chips	Z	P X Y Z Accep numbe When Y conducto	ermit star	ndard (mm) $\leq 1/8L$ $\leq 1/3W$ $\leq 1/2t$ 2 neglect the let depend on X (mm) enter into or do not ch the	M/ ngth c ≤1/10	AJ of X, un L, Y≤	MIN √ 1/2W。 MIN

	MODEL	NO.	PAGE
P-TEC	PCOG240160P-O series	SPEC ONLY	22

		refer to 6.3.4 ge the conduct						
	interface seal	rubber cra	ack (outer	emps dumug	(mm)		MAJ	MIN
	crack)			X	≤1/8 L			
				Y	≤1/2H			
6.3.4.3		Y	T	Z	$\leq 1/2t$			$\checkmark$
			$\bigcirc$	Accept	2			
	z			number Seal edge rul	bber inner cra	ck conf	orm to th	e standard
					en the back of			
-	ass thickness, L-	length,	Hdistan	ce. W—glass s	stage width			
6.3.5 othe	rs							Assert
order	item			description	1	MAJ	MIN	Accept standard
								Reject or
6.3.5.1	coloration/background One prod			uct, different c	et, different color			refer to limited
								sample
6.3.5.2	Leak ink(	LC)	LC) /			$\checkmark$		reject
6.3.5.3	Without prote	ect film		/			$\checkmark$	reject
6.4 bacl	klight component	nts	•				•	•
order	item		de	escription		MAJ	MIN	Accept standard
6.4.1	Backlight unlit, wrong color			/		$\checkmark$		reject
6.4.2	Color deviation	A /		from the samp wing after test	·			Refer to sample and drawing
	Duichturger	Lit up, l	ightness di	ffer from the s	ample, or			Refer to
6.4.3	Brightness deviation	do not n	natch the di	rawing after te				sample and
				nge of±30%.				drawing Refer to
6.4.4	LED uneven	A ·	orightness u g specifica	ineven, exceed	d the			sample and
	Q <sub>11</sub> = + /1'	uawill	g specifica					drawing
6.4.5	Spot/line segment	There an	re tainted, s	egment when	lit up.		$\checkmark$	Refer to 6.3.1/6.3.2
6.5 Mer	ntal frame				I		I	
order	item		(	description		MAJ	MIN	Accept standard
1	material/surfa		Mental fra	me/surface ap	proach	$\checkmark$		reject

	MODEL	NO.	PAGE
P-TEC	PCOG240160P-O series	SPEC ONLY	23

6.5.2	Twist un- quality/withou twisting		$\checkmark$		reject
6.5.3	oxidation, pair stripping, discoloration dent ,segmen	length≤5.0mm, width≤0.05mm line defect exceed 2 point, positive dent,		V	reject
6.5.4	prick	Prick is too long, enter into viewing area		$\checkmark$	reject
6.6 PCB	B/COB part		1		
order	item	description	MAJ	MIN	Accept standard
6.6.1	Seal rubber defect	<ol> <li>COB inner round white remark line have PAD out reveal</li> <li>height exceed the document/drawing specification.</li> <li>COB seal rubber should in white remark, the largest out scale can not exceed remark radius 2MM</li> <li>COB surface has clear lien assemble mark, some even through the pinhole.</li> <li>COB surface pinhole diameter over 0.25mm or have tainted</li> </ol>		$\checkmark$	reject
6.6.2	PCB cosmetic defect	<ol> <li>PCB golden figure surface can not have oxidation, dirt.</li> <li>PCB can not appear bubble caused by reflow.</li> <li>PCB green oil drop /segment lead to leak copper. Use mending, circuit diameterψ can not over 1.3mm, other diameterψ can not over 2.6mm, total less than 10 point. otherwise reject.</li> </ol>		$\checkmark$	reject
6.6.3	Components mistake	<ol> <li>PCB components inconsistent with drawing. Find wrong pitch, more or less pitch, polar reverse (LCD voltage side circuit/BL current limit resistance modify, only if customer have special require, otherwise do not control)</li> <li>The JUMP of PCB shot need refer to the structure picture, appear more or less</li> </ol>	V	$\checkmark$	reject

	)	MODEL NO.					PAGE
	P-TE	C	PCOG240160P-O series	SPE	EC ONI	X	24
.7 SM	T part (vague pa	3. cus con sup den	dering. stomer have special require of mponent, mode specification oplier should conform to tech mand. Otherwise reject. r to IPC-A-610C)	n and			
Order	I purt (vague pa		Description		MAJ	MIN	Accept standard
6.7.1	Soldering defect		older, fake solder, missing solder tin un-dissolved	er,		$\checkmark$	reject
6.7.2	Solder ball/bridge		ball/bridge drop lead to spot sh	ort.		$\checkmark$	reject
6.7.3	DIP parts	~	arts, keypad, connection appe ng and tilted.	ar		$\checkmark$	reject
6.7.4	Spot shape		dent, can not form to cover solo lder, otherwise reject	der or			reject
6.7.5	Component out reveal	After damag	cutting, just left 0.5mm~2mm,ca ge solder surface and covered the onent foot. Otherwise reject.			$\checkmark$	reject
6.7.6	Cosmetic defect	PCB	residues appear tawny or coke solder spot remained white mis- ues after clean.			$\checkmark$	reject
.8 The	ermal press part	(contai	in H/S, FPC)				
Order	item		description		MAJ	MIN	Accept standard
6.8.1	Model specifi cations do not match				$\checkmark$		reject
6.8.2	Scale/position	spec diel PDA	rial scale must in the drawing cification range, the contact are ectric material and the body (T A) should be above 1/2, and ocation must control in specifica	ΓΟ, the		$\checkmark$	Accept
	Scale/position Thermal press dirt	spec diel PDA disle Thern OF	cification range, the contact are ectric material and the body (T A) should be above 1/2, and	TO, the ation short,		√	Accept
6.8.3	Thermal	spec diel PDA disle Thern OF	cification range, the contact are ectric material and the body (TA) should be above $1/2$ , and ocation must control in specifica mal area tainted can not lead to a $\zeta$ , in through position, dirt ar	TO, the ation short,			
6.8.3 6.8.4	Thermal press dirt	spec diel PDA disle Thern OF sm	cification range, the contact are ectric material and the body (TA) should be above $1/2$ , and ocation must control in specifica mal area tainted can not lead to a $\zeta$ , in through position, dirt ar	TO, the ation short,		√	accept Refer to limited sample
6.8.2 6.8.3 6.8.4 .9 conr order	Thermal press dirt creases	spec diel PD/ disle Thern OF sm	cification range, the contact are ectric material and the body (TA) should be above $1/2$ , and ocation must control in specifica mal area tainted can not lead to a $\zeta$ , in through position, dirt ar	TO, the ation short, rea is	MAJ	√	accept Refer to limited

	MODEL	PAGE	
P-TEC	PCOG240160P-O series	SPEC ONLY	25

6.9.2	Position and order	Solder position should consistent with the drawing .		reject
6.9.3	cosmetic	<ol> <li>the body of our connect component and the PIN foot have solder-helping.</li> <li>PIN connection PIN deformation bigger than PIN width 1/2.</li> </ol>	$\checkmark$	reject

#### 6.10 General visual

order	item	description	MAJ	MIN	Accept standard
6.10.1	Connect material	FPC golden figure or H/S,FFC out part of PIN leak copper or material, have damaged. FPC,FFC,COF,H/S connected material curved (except for original). FPC、PCB golden figure bigger than 1PIN width. FPC/FFC material segment, crease exceed the specification.		$\checkmark$	reject
6.10.2	Protect defect	Protect film do not cover circuit totally ( LikeH/S, FFC, FPC) or not contact with interface, or add on PIN outer part.		$\checkmark$	reject
6.10.3	Visual dirty	The surface of end products have dirt, rubber, PCB/COB un-welding area has solder ball. The defective remark or label do not clean.			reject
6.10.4	Assembly black spot	Add backlight, taint and black spot		$\checkmark$	Refer to 6.3.1
6.10.5	Product remark	Model defer from approved remark and technique requirement, position, vague and leak.			reject
6.10.6	Inner product packing	Packing inconsistent with requirement, segment short, wrong amount. And inconsistent with shipment remark/ order demand.			reject

	MODE	PAGE			
P-TEC	PCOG240160P-O series	SPEC	ONLY	26	
Test item	Condition	Time(hrs)	Accent	standard	
high temp storage	80°C	120	Ашр	stanuaru	
high temperature operating	70°C	120			
low temperature storage	-30°C	120	Before an	nd after test,	
low temperature operating	-20°C	120	function an	nd cosmetic is	
temperature& humility test	40°C/ 90%RH	120	qua	lified.	
temperature shock	$-20^{\circ}C \leftarrow 25^{\circ}C \rightarrow +70^{\circ}C$ (30 min $\leftarrow 5 min \rightarrow 30min)$	10 cycles			

Note: If customer have requirement, please put forward on the item development. (high/low temperature storage and experiment, the temperature refer to specific requirement),  $\pm 5^{\circ}$ C deviation could be accept.

#### 8. Packing

- 8.1 Product design must meet the requirement of packing design and check on delivery. Besides the product name, specification, model, quantity and date on the label, the quality chapter is necessary after checked by QA. Incomplete or mistake, is not qualified.
- 8.2 When the safety of the packing (earthquake, moisture-proof, anti-static, anti-squeezed) exist problem, not qualified.
- 8.3 When customer's special requirement is confirmed and accepted by interior, carry it out and check on delivery.
- 8.4 Environment protected and unprotected products must have obvious distinguished remark. The present remark adopts "RoHS". If customer have special requirement, use the appointed remark or label.

#### 9. Others

9.1 No-provision or compromised item, depend on two side agreement and limited prototype.